



ICED 13

THE 19TH INTERNATIONAL CONFERENCE
ON ENGINEERING DESIGN

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Seoul, Korea

Organised By

Creative Design Institute, Sungkyunkwan University
and the Design Society

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DESIGN FOR HARMONIES

VOLUME 1: DESIGN PROCESSES

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Preface by the Programme Chair

We welcome you to the proceedings of arguably the biggest conference on engineering design: 19th International Conference on Engineering Design (ICED13) held in Sungkyunkwan University, Seoul, Korea!

This proceedings is a compilation of the 342 peer-reviewed and accepted papers submitted to ICED13. The proceedings is published in different forms: a book of abstracts, a soft-copy of proceedings on a USB-based memory device and a hard-copy of proceedings, which is available via a print-on-demand supplier. All these different forms of proceedings are numbered against both Design Society and ISSN referencing to allow wider access, better referencing and improved citation in the near and distant future. All the accepted papers are divided among the following 9 themes: Design Processes; Design Theory and Research Methodology; Design Organisation and Management; Products, Services and Systems Design; Design for X, Design to X; Design Information and Knowledge; Human Behaviour in Design; Design Education; and Design Methods and Tools. The hard-copy of the proceedings is in turn divided into 9 volumes where each volume comprises papers from a theme. All the accepted papers are presented in podium or discussion sessions in the conference. It is important to make it explicit that all the accepted papers have successfully cleared the criteria for acceptance in ICED13. The division into podium and discussion sessions is solely based on grouping similar papers so as to allow relevant, connected, lively and stimulating presentations and discussions. For this year's conference we have introduced a number of novel schemes to reduce the bureaucratic load for authors and organisers and, it is hoped, to increase the quality of the conference. To name a few: (i) automatic production of the cover page of papers based on title of paper, details of authors, abstract and list of keywords in the Conference Management System, (ii) electronic acceptance of terms and conditions in copyrights, (iii) feedback of acceptance and quality of reviews to reviewers from authors, etc.

This proceedings is a consequence of dedicated efforts of many people, namely, the authors, the reviewers, the chairs and associate chairs of the various themes, and the members of the Programme Committee. The Programme Chair on behalf of Programme Committee would like to acknowledge the contributions of: (a) Authors for submitting papers, (b) Reviewers for providing timely comments and feedbacks to improve the quality of papers, (c) Chairs and Associate Chairs of themes for assisting in selection of reviewers, providing directions for improvements to papers with the status of major revisions, and helping in the final decisions of papers.

We hope that you enjoy the programme of ICED13 as much as we have enjoyed creating and organising it.



A handwritten signature in black ink, appearing to read 'Udo Lindemann'.

Udo Lindemann
Programme Chair



A handwritten signature in black ink, appearing to read 'Srinivasan V'.

Srinivasan V
Assistant Programme Chair

Preface by ICED13 Conference Chair

Welcome to the 19th International Conference on Engineering Design 2013 (ICED13), and its conference proceedings. The theme of ICED13, *Design for Harmonies*, is well reflected in the programme and papers of the conference. As design practice and research make progress, integration and incorporation of diverse viewpoints take more essential roles. ICED13 will make its mark in the history of ICED and the Design Society as an important cornerstone for harmonies in design.

Increasing numbers of presentations in topics like human behavior in design and product, service and systems design indicate that issues of harmonies of products and services and those of human-centered views and technology support are at the core of design research. With continued excellence in the topics of design methods and tools, design information and knowledge and design processes, strong research foundations of design have been confirmed in the programme. Presentations in design organisation and management, design for X, design to X, and design theory and research methodology also demonstrate the leadership of the Design Society community in these important issues. Design education is yet another important area where new needs and requirements appear as the roles of design become broader. As Seoul is the very first Asian city hosting ICED, more papers from Asian countries appear in ICED13. This reflects harmonies of East and West being strengthened in design research. ICED13 will make a good transition for drawing more such harmonies.

In addition to a technical programme of keynote, podium and discussion sessions, ICED13 has organized a few special events such as the Young Members Event. Ten selected presentations by young designers and design researchers will address the Future of Design. This event is open to the (young) public so that diverse harmonies can be achieved by the attendees. With opening and closing ceremonies and receptions as well as a conference banquet, diverse opportunities for cultural harmonies are prepared. For example, Korean traditional culture experiences are available for conference attendees and accompanying guests together with old Korean traditional buildings in order to draw harmonies from the Old and the New. The optional Gangnam-Style tour will introduce modern Korean culture as featured in the world hit music video.

We hope you enjoy ICED 13 and have the fun and excitement of Design for Harmonies.



A handwritten signature in black ink, appearing to read 'Yong Se Kim'.

Yong Se Kim
Conference Chair



A handwritten signature in black ink, appearing to read 'Sang Won Lee'.

Sang Won Lee
Assistant Conference Chair

Preface by the Design Society President

The 2013 International Conference on Engineering Design (ICED) will be the nineteenth held since the conference series was inaugurated in 1981. It will also be the sixth held under the auspices of the Design Society, an international society founded in 2001 to develop an understanding of all aspects of design. The previous five conferences have been in Stockholm, Melbourne, Paris, Stanford (California) and Copenhagen, and by holding the conference in Asia for the first time it is surely established as a truly world-wide event. The 2013 conference continues the tradition of holding the conference in an exciting location with a vibrant design research community and for which design is important to local industry and commerce. Seoul is exceptional in this regard, the dynamic heart of the world's second largest metropolis whose success is built on great design and engineering.

ICED13 also continues the format, established in 2009 and continued in 2011, of a conference programme made up of plenary sessions, podium presentations, discussion sessions with focused debate and workshops led by the Design Society's Special Interest Groups. We hope that this varied programme, combined with extensive opportunities for networking, will provide an exciting opportunity for researchers and practitioners to learn about the latest developments in design research and practice.

Organising an international conference takes an enormous amount of work, and I would like to express the thanks of the Society to the great team that has worked over many months to make the Conference a success. Especially I would like to thank Yong Se Kim, Sang Won Lee and colleagues at Sungkyunkwan University for their great work in the Organising Committee, and Udo Lindemann, Srinivasan V and the Programme Committee for bringing together such an excellent programme. Of course, their work would be in vain without the fantastic contributions of the authors, reviewers, theme chairs and session chairs, and the thanks of the Society are due to all of them.



A handwritten signature in black ink, which appears to read "Chris McMahon". The signature is fluid and cursive.

Chris McMahon
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Table of Contents

Preface by ICED13 Programme Chair
Preface by ICED13 Conference Chair
Preface by the Design Society President
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VOLUME 1: DESIGN PROCESSES

Including product features in the development of engineering design processes <i>Jeppe Bjerrum Ulrikkeholm, Lars Hvam</i>	1-1
When to check for deviations in the design process – An approach to determine a systematic checkpoint schedule <i>Martina Carolina Wickel, Florian Behncke, Udo Lindemann</i>	1-11
Supporting the modification process of products through a change management tool <i>Marco Malatesta, Roberto Raffaelli, Maura Mengoni, Michele Germani</i>	1-21
Comparison of engineering change cause analysis in literature and industrial practice <i>Nepomuk Chucholowski, Stefan Langer, Florian Behncke, Udo Lindemann</i>	1-31
Identifying uncertainties within structural complexity management <i>Daniel Kasperek, Andreas Kohn, Maik Maurer</i>	1-41
Main factor identification for early negotiation in product design <i>Yun Ye, Marija Jankovic, Jean-Claude Bocquet</i>	1-51
Process-integrated analysis of the development situation for an efficient simulation planning <i>Jochen Reitmeier, Kristin Paetzold</i>	1-61
Understanding task structure in DSM: Mining dependency using process event logs <i>Lijun Lan, Ying Liu, Han Tong Loh</i>	1-69
Transforming user requirements into technical requirements for development of a new control access for people with reduced environmental impact <i>Guilherme Breier, Marcia Elisa Echevest, Carla ten Caten</i>	1-79
Deploying decision criteria in a cyclical decision process for the product planning phase <i>Sebastian A. Schenk, Sebastian Spörl, Florian G. H. Behncke, Robert Orawski, Markus Mörtl</i>	1-89
Towards a more event-driven NPD process: First experiences with attempts of implementation in the front-end phase <i>Geir Ringen, Torgeir Welø</i>	1-99

Idea relevancy assessment in preparation of product development <i>Milan Stevanovic, Dorian Marjanovic, Mario Storga</i>	1-109
Framework for the development of maturity based self-assessments for process improvement <i>Arno Kühn, Tobias Bensiek, Jürgen Gausemeier</i>	1-119
Spatial design supporting the management of radical improvements within the manufacturing industry <i>Jennie Schaeffer Andersson, Mats Jackson</i>	1-129
A methodical approach for designing innovative products based on computer aided functional modelling <i>Jan Erik Heller, Johannes van der Beek, Claudia Dittmann, Jörg Feldhusen</i>	1-139
Crowdsourcing in design research - Potentials & limitations <i>Soren Ingomar Petersen</i>	1-149
Assumptions for incremental innovations in SMEs <i>Robert Watty</i>	1-159
Open innovation and idea generation in SMEs <i>Silje Helene Aschehoug, Geir Ringen</i>	1-169
Three layers of openness in design: Examining the open paradigm in design research <i>Tanja Aitamurto, Dónal Holland, Sofia Hussain</i>	1-179
A unified approach for systematic and participatory design <i>Kentaro Watanabe, Tomohiro Fukuhara, Hiroyasu Miwa, Takuichi Nishimura</i>	1-191
Collaborative product design and development for commercialization of invention <i>James Ah-Kat Tan</i>	1-201
Fighting poverty through design: Comparing design processes for the base and the top of the world income pyramid <i>Santosh Jagtap, Andreas Larsson, Viktor Hiort, Elin Olander, Anders Warell, Pramod Khadilkar</i>	1-211
Design and testing of a new medical rail-adapter product <i>Xiaolong Wu, Young Mi Choi</i>	1-221
Development of a design process to design for people with dementia and their extended care network - Learning from a case study <i>Rens Brankaert, Elke den Ouden</i>	1-229
Design and business model experimentation <i>Soren Ingomar Petersen</i>	1-239
Case study: Evidence of prototyping roles in conceptual design <i>Tim Hess, Joshua David Summers</i>	1-249
Exploratory study of the inclusion of territorial resources in design process <i>Romain Allais, Reyes Tatiana, Roucoules Lionel</i>	1-259

Investigation of the exogenous factors affecting the design analysis process <i>Martin Eriksson, Damien Motte</i>	1-269
Designers' promises or users' expectations? <i>Donata Gabelloni, Gualtiero Fantoni</i>	1-279
From product development to market introduction: A co-citation analysis in the field of ramp-up <i>Steffen Elstner, Dieter Krause</i>	1-289
Functional characteristics of running shoes for different user groups <i>Patrick Clifton, Aleksandar Subic, Mike Burton, Anthony Bedford, Adrian Schembri</i>	1-299
Multistakeholder analysis of requirements to design real innovations <i>Marco Cantamessa, Francesca Montagna, Maria Messina</i>	1-309
A system-level thermal design specification development of electronic products considering software changes <i>Yoshio Muraoka, Kenichi Seki, Hidekazu Nishimura</i>	1-319
Customer focused requirement engineering and system design for plug-in hybrid electric vehicles (PHEV) <i>Benedikt Johannes Nies, Robert Orawski, Udo Lindemann</i>	1-329
Robust conception of vehicles considering region-specific requirements <i>Frank Nehuis, Jafet G. Sánchez Ruelas, Carsten Stechert, Thomas Vietor</i>	1-339
Reuse of requirements: An approach with a generic requirements pool <i>Robert Orawski, Christoph Hein, Dieter Polenov, Maik Holle, Sebastian Schenkl, Markus Mörtl, Udo Lindemann</i>	1-349
Bringing objectivity to requirements – Using property networks for a more complete requirement acquisition <i>Benjamin Röder, Tim Gläßer, Herbert Birkhofer</i>	1-359
An empirical investigation of requirement evolution in an industrial project <i>Weili Dai, Marco Aurisicchio</i>	1-369
Modeling systems of objectives in engineering design practice <i>Albert Albers, Simon Klingler, Bjoern Ebel</i>	1-379
Overview of methods supporting product planning: Open research issues <i>Daniele Bacciotti, Yuri Borjianni, Federico Rotini</i>	1-389
The creative act is done on the hybrid machine <i>Robert E. Wendrich</i>	1-399
Using design database structures to characterize freedom-to-operate in a design space: A legal case study <i>Katherine Fu, James Dilmore, Jonathan Cagan, Charles H. Dougherty Jr.</i>	1-409
Towards an approach to integrate technological evolution into product design <i>Yannick Chapuis, Frédéric Demoly, Samuel Gomes</i>	1-419
Suitable methods for process modeling and process optimization <i>Michael Schabacker, Nikoletta Szélig, Sándor Vajna</i>	1-429

Lean product development in practice: Insights from 4 companies <i>Ghadir I. Siyam, Katharina Kirner, David C. Wynn, Udo Lindemann, P. John Clarkson</i>	1-439
An integrative design analysis process model with considerations from quality assurance <i>Martin Eriksson, Damien Motte</i>	1-449
Design process commonalities in trans-disciplinary design <i>A.J. Qureshi, Kilian Gericke, Lucienne Blessing</i>	1-459